

## STANDARD EDGE CONNECTORS





✓ Active



PRODUCT DRAWING



3D PDF

TE CONNECTIVITY (TE)

## CONNECTOR ASSEMBLY, DUAL POSITIONS, 050

Dual Connection, Standard

5650090-6

TE Internal Number: 5650090-6

Always EU RoHS/ELV Compliant

Product Type Connector

Number of Dual Positions 30

Number of Rows 2

Housing Color Brown

Housing Material High Temperature Thermoplastic

Product Drawings CONNECTOR ASSEMBLY, DUAL POSITION, .050 SEERIES

PDF **English** 

CAD Files Customer View Model

2D\_DXF.ZIP **English** 

**Customer View Model** 

3D\_IGS.ZIP English

Customer View Model

3D\_STP.ZIP English

PDF **English** 

**Product Specifications** 

Product Specification Connector, Card Edge, .050 Centerline

PDF **English** 

Application Specification Card Edge Printed Circuit (PC) Board Connectors

PDF **English** 

Product Environmental Compliance

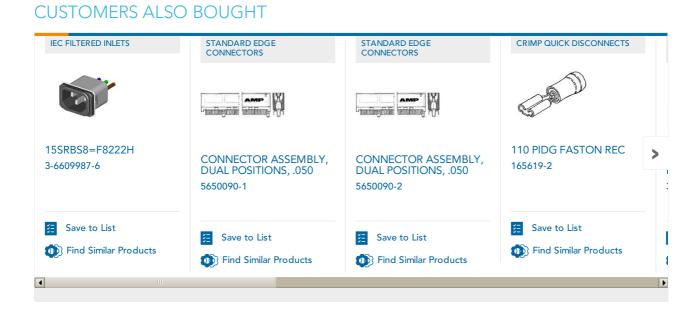
TE Material Declaration CONNECTOR ASSEMBLY, DUAL POSITIONS, .050

PDF **English** 

Please review product documents or contact us for the latest agency approval information. Please Note: Use the Product Drawing for all design activity.

Product Type Features	Product Type	Connector
	Connector Style	Receptacle
	PCB Mounting Orientation	Vertical
	Connector System	Board-to-Board
	Post Type	Solder Post
	Connector Type	Connector Assembly
	Applies To	Printed Circuit Board
	Type of Connector	Card Edge
Configuration Features	Number of Dual Positions	30
	Number of Rows	2
	Selectively Loaded	No
	End Caps	Without
	Number of Pylons	2
Electrical Characteristics	Operating Voltage	203 VAC
	Hot Pluggable	No
Body Features	Color	Brown
Contact Features	Contact Termination Area Plating Material	Tin-Lead
Contact Features	Contact Termination Area Plating Material  Contact Termination Area Plating Material Finish	Tin-Lead Bright
Contact Features	Contact Termination Area Plating Material	
Contact Features	Contact Termination Area Plating Material Finish	Bright
Contact Features	Contact Termination Area Plating Material Finish Contact Current Rating (A)	Bright
Contact Features	Contact Termination Area Plating Material Finish  Contact Current Rating (A)  Contact Mating Area Plating Material	Bright  1 Gold
Contact Features	Contact Termination Area Plating Material Finish  Contact Current Rating (A)  Contact Mating Area Plating Material  Contact Termination Area Plating Thickness	Bright  1  Gold  2.54 μm [ 100 μin ]
Contact Features	Contact Termination Area Plating Material Finish  Contact Current Rating (A)  Contact Mating Area Plating Material  Contact Termination Area Plating Thickness  Underplate Material	Bright  1  Gold  2.54 µm [ 100 µin ]  Nickel
Contact Features	Contact Termination Area Plating Material Finish  Contact Current Rating (A)  Contact Mating Area Plating Material  Contact Termination Area Plating Thickness  Underplate Material  Contact Mating Area Plating Thickness (µm)	Bright  1  Gold  2.54 μm [ 100 μin ]  Nickel  .76
Contact Features	Contact Termination Area Plating Material Finish  Contact Current Rating (A)  Contact Mating Area Plating Material  Contact Termination Area Plating Thickness  Underplate Material  Contact Mating Area Plating Thickness (µm)  Contact Base Material	Bright  1  Gold  2.54 µm [ 100 µin ]  Nickel  .76  Phosphor Bronze
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	Contact Termination Area Plating Material Finish  Contact Current Rating (A)  Contact Mating Area Plating Material  Contact Termination Area Plating Thickness  Underplate Material  Contact Mating Area Plating Thickness (µm)  Contact Base Material  Solder Tail Contact Plating Material  Contact Type	Bright  1  Gold  2.54 µm [ 100 µin ]  Nickel  .76  Phosphor Bronze  Tin-Lead  Socket
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	PCB Mount Retention  Mating Alignment	With
Housing Features	Housing Color	Brown
	Housing Material	High Temperature Thermoplastic
	Centerline	1.27 mm [ .05 in ]
Dimensions	Height	13.97 mm [ .55 in ]
	Card Slot Depth	7.62 mm [ .3 in ]
	Daughter Board Thickness	1.37 – 1.78 mm [ .054 – .07 in ]
Usage Conditions	Operating Temperature Range (°C)	-55 – 85
Packaging Features	Packaging Quantity	35
	Packaging Method	Вох
Product Compliance	Statement of Compliance	



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